



Biomaterials and Biofabrication 2021

Guest Editors:

Prof. Dr. Jangho Kim

Department of Rural and
Biosystems Engineering,
Chonnam National University,
Gwangju 61186, Republic of
Korea

Prof. Dr. Seok Ho Cho

Department of Clothing and
Textiles, Chonnam National
University, 77, Yongbong-ro, Buk-
gu, Gwangju 61186, Korea

Prof. Dr. Hee-Gyeong Yi

Department of Rural and
Biosystems Engineering,
Chonnam National University,
Gwangju 61186, Korea

Deadline for manuscript
submissions:

closed (31 December 2021)

Message from the Guest Editors

Dear Colleagues,

In this Special Issue, 'Biomaterials and Biofabrication 2021', with our previous successful special issue of 'Biomaterials and Biofabrication', we have started to invite new submissions exploring the up-to-date findings and research related to biofabrication (e.g., nano- and micro-fabrication and 3D bioprinting), biomaterials (e.g., decellularized extracellular matrix, conductive hydrogels, and graphene) and electronic technologies for bio/healthcare application (e.g., implantable biosensors, drug delivery systems, organoids, organ-on-a-chips, bioelectronics and wearable electronics). Communications and reviews are also welcomed.

Prof. Dr. Jangho Kim
Prof. Dr. Seok Ho Cho
Prof. Dr. Hee-Gyeong Yi
Guest Editors





an Open Access Journal by MDPI

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo
Dipartimento di Fisica,
Politecnico di Milano, Piazza L.
da Vinci 32, 20133 Milano, Italy

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Author Benefits

Open Access: free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility: indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, Embase, CAPlus / SciFinder, and other databases.

Journal Rank: JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

Contact Us

Applied Sciences Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland

Tel: +41 61 683 77 34
www.mdpi.com

mdpi.com/journal/applsci
applsci@mdpi.com
[X@Applsci](https://twitter.com/AtApplsci)